U.S. PTO 12/289435 10/28/2008

Form PTO-1595 (Rev. 08/08)
OMB No. 0651-0027 (exp. 9/30/2008)

11-10-2008

RECORDATION FOR	M COVER
PATENTS	ONLY 103534151
To the Director of the U.S. Patent and Trademark Office: Please	record the attached documents or the new address(es) below.
Name of conveying party(ies):	2. Name and address of receiving party(ies)
Shingo Setono	Name: FUNAI ELECTRIC CO. LTD.
	Internal Address:
Additional name(s) of conveying party(ies) attached? Yes X No	Street Address:
3. Nature of conveyance/Execution Date(s):	·
Execution Date(s): October 9, 2008	7-7-1, Nakagaito, Daito-shi
X Assignment Merger Change of Name	
Security Agreement Joint Research Agreement	City: Osaka
Government Interest Assignment	State:
Executive Order 9424, Confirmatory License	Country: Japan Zip: 574-0013
Other	Additional name(s) & address(es) Yes X No attached?
Additional numbers attached?	Yes X No
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Robert J. Gaybrick MORGAN LEWIS & BOCKIUS LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Internal Address: Atty. Dkt.: 060326-5270US	Authorized to be charged by credit card
Street Address: 1111 Pennsylvania Ave NW	X Authorized to be charged to deposit account
	Enclosed
-	None required (government interest not affecting title
City: Washington	8. Payment Information
State: DC Zip: 20004	a. Credit Card Last 4 Numbers
Phone Number: (202) 739-3000	Expiration Date
Fax Number: (202) 739-3001 Email Address: patents@morganlewis.com	b. Deposit Account Number 50-0310 Authorized User Name Robert J. Goodell
	Todate. Oddan
9. Signature:	
Signature	October 28, 2008 Date

Robert J. Goodell - 41,040

Name of Person Signing

11/07/2008 DBYRNE 00000022 500310

Total number of pages including cover sheet, attachments, and documents:

12289435

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48.00 DA

ATTORNEY DOCKET NO.: SOLE/JOINT INVENTION (U.S. Rights Only)

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

OPTICAL DISC APPARATUS		
for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on, (Application No); and		
WHEREAS, FUNAI ELECTRIC CO., LTD., a corporation of Japan, whose post office address is 7-7-1, Nakagaito, Daito-shi, Osaka 574-0013 Japan, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;		
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;		
AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns. AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No, filed) the filing date and application number of said application when known.		
IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).		
Il Name of First Assignor Assignor's Signature Date	\neg	
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dress C/O FUNAI ELECTRIC CO., LTD., 7-7-1, Nakagaito, Daito-shi, Osaka 574-0013 Japan Citizenship	į.	

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RECORDED: 10/28/2008

PATENT REEL: 021814 FRAME: 0564